

## **Surface Mount Schottky Power Rectifier**

### POWERMITE® Power Surface Mount Package

#### MBRM1H100T3G

The Schottky Powermite<sup>®</sup> employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite<sup>®</sup> has the same thermal performance as the SMA while being 50% smaller in footprint area. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are AC–DC and DC–DC converters, reverse battery protection, and "ORing" of multiple supply voltages and any other application where performance and size are critical.

#### **Features**

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm<sup>2</sup>
- Low V<sub>F</sub> Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink
- This is a Pb-Free Device

#### **Mechanical Characteristics:**

- Powermite® is JEDEC Registered as D0-216AA
- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 16.3 mg (Approximately)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Maximum for 10 Seconds

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## SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES, 100 VOLTS



POWERMITE CASE 457 PLASTIC

#### MARKING DIAGRAM



M = Date Code
B1H = Device Code
Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBRM1H100T3G	Powermite (Pb-Free)	12000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### MBRM1H100T3G

#### **MAXIMUM RATINGS**

Symbol	Rating	Value	Unit
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	100	V
I <sub>O</sub>	Average Rectified Forward Current (T <sub>L</sub> = 168°C)	1.0	Α
I <sub>FSM</sub>	Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	50	Α
T <sub>stg</sub> , T <sub>J</sub>	Storage and Operating Junction Temperature Range (Note 1)	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Symbol	Characteristic		Unit
$\Psi_{\sf JCL}$	Thermal Resistance, Junction-to-Lead (Note 2)	12	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	75	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 3)	260	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic	Value	Unit
V <sub>F</sub>	Maximum Instantaneous Forward Voltage (Note 4)	0.76 0.84 0.61 0.68	V
I <sub>R</sub>	Maximum Instantaneous Reverse Current (Note 4) (Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>J</sub> = 125°C)	20 1.0	μA mA

<sup>2.</sup> Mounted with 700 mm<sup>2</sup> copper pad size (Approximately 1 in<sup>2</sup>) 1 oz FR4 Board.

<sup>1.</sup> The heat generated must be less than the thermal conductivity from Junction–to–Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

<sup>3.</sup> Mounted with pad size approximately 20 mm<sup>2</sup> copper, 1 oz FR4 Board.

<sup>4.</sup> Pulse Test: Pulse Width  $\leq$  380  $\mu$ s, Duty Cycle  $\leq$  2.0%.

#### MBRM1H100T3G

#### **TYPICAL CHARACTERISTICS**

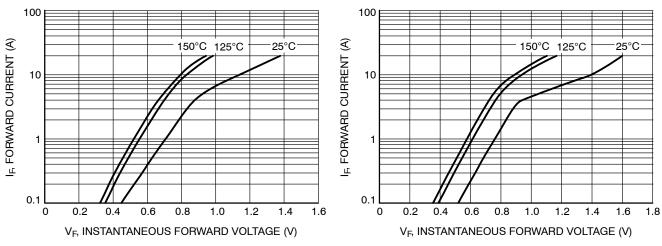
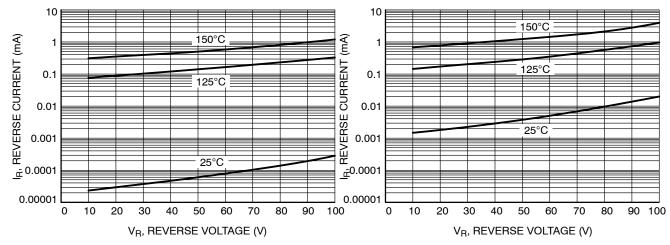


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage



**Figure 3. Typical Reverse Current** 

Figure 4. Maximum Reverse Current

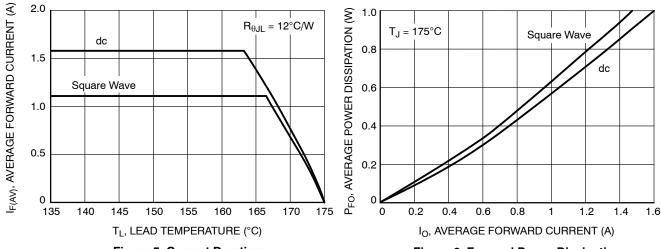


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

#### MBRM1H100T3G

#### TYPICAL CHARACTERISTICS (continued)

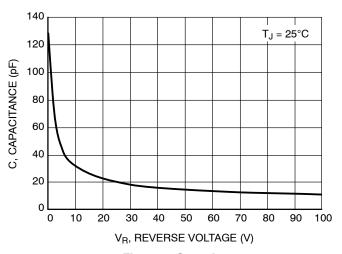


Figure 7. Capacitance

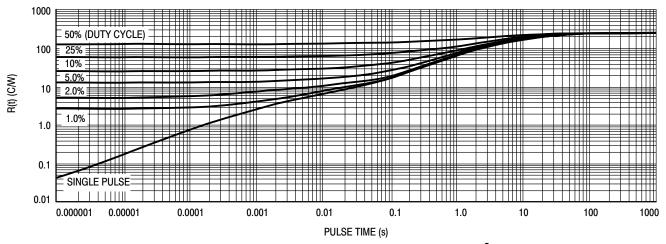


Figure 8. Thermal Response, Junction-to-Ambient (20 mm<sup>2</sup> pad)

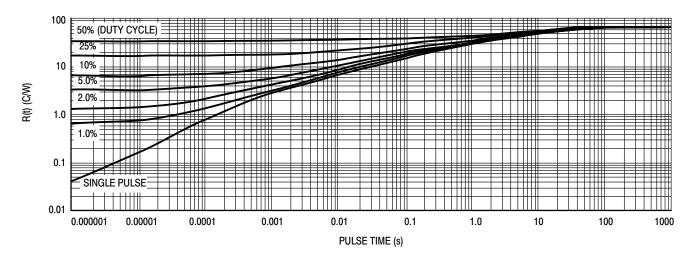


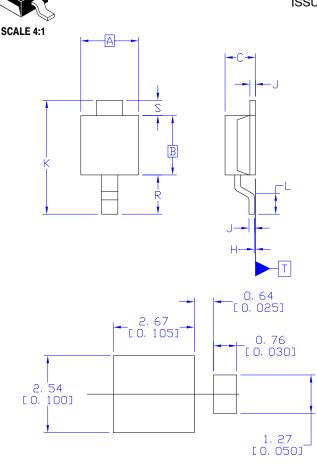
Figure 9. Thermal Response, Junction-to-Ambient (1 in<sup>2</sup> pad)

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**DATE 12 JAN 2022** 



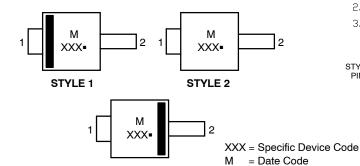
RECOMMENDED MOUNTING FOOTPRINT

# ◆ 0, 08 (0, 003) M T B S C S

◆ 0.08 (0.003) M T BS CS

	MILLIMETERS		INCHES		
DIM	MIN.	MAX.	MIN.	MAX.	
Α	1. 75	2, 05	0, 069	0. 081	
В	1. 75	2. 18	0, 069	0, 086	
С	0. 85	1. 15	0. 033	0. 045	
D	0. 40	0. 69	0. 016	0. 027	
F	0. 70	1. 00	0. 028	0. 039	
Н	-0. 05	0. 10	-0. 002	0. 004	
J	0.10	0, 25	0. 004	0.010	
К	3, 60	3, 90	0.142	0. 154	
L	0, 50	0, 80	0, 020	0. 031	
R	1. 20	1, 50	0. 047	0. 059	
S	0, 50 REF		0.019 REF		

#### **GENERIC MARKING DIAGRAMS\***



STYLE 3

#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS 2.
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN O. 15 AND O. 30mm FROM THE TERMINAL TIP.

STYLE 1: PIN 1. CATHODE 2. ANODE

STYLE 2: PIN 1. ANODE OR CATHODE STYLE 3: PIN 1. ANODE 2. CATHODE

2. CATHODE OR ANODE (BI-DIRECTIONAL)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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